



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of:

Ravkin et al.

Application No: 10/607,611

Filed: June 27, 2003

For: **APPARATUS AND METHOD FOR
DEPOSITING AND PLANARIZING
THIN FILMS OF SEMICONDUCTOR
WAFERS**

)
) Group Art Unit: 1742

)
) Examiner: Wilkins III, H.

)
) Atty. Docket No: LAM2P428

)
) Date: June 26, 2006

*OK to
Enter
Harry Will*

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Alexandria, VA 22313-1450 on June 26, 2006.

Signed: _____

Kay Harlow
Kay Harlow

AMENDMENT

Honorable Commissioner for Patents
Alexandria VA 22313-1450

Dear Sir:

In response to the Office Action dated April 24, 2006, the term to respond extends to July 24, 2006. Please enter this amendment and remarks.

Amendments to the claims are reflected in the listing of claims which begin on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.